

SOT-363 Plastic-Encapsulate MOSFET

50V Dual N-Channel MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
50V	0.8Ω@10V	0.34A
	0.85Ω@4.5V	

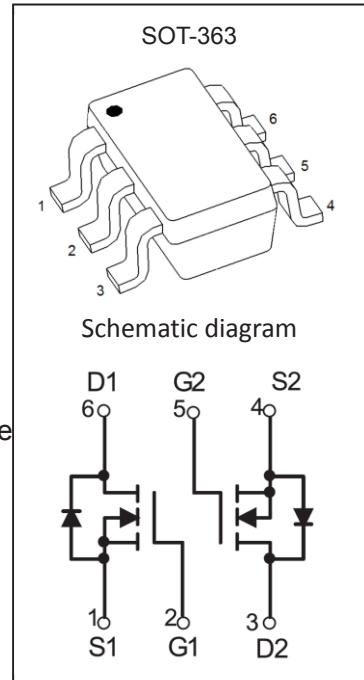
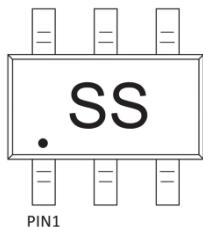
Feature

- High density cell design for extremely low $R_{DS(on)}$
- Rugged and Reliable

Application

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

MARKING:



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	0.34	A
Power Dissipation	P_D	150	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

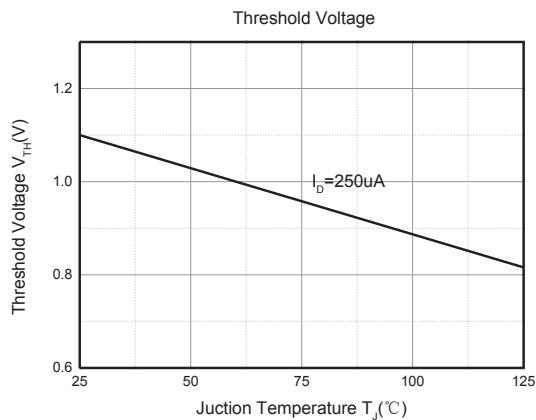
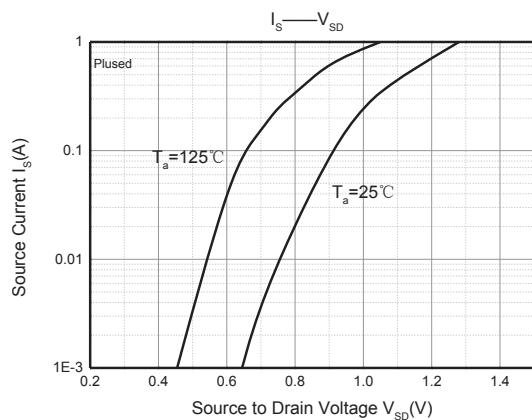
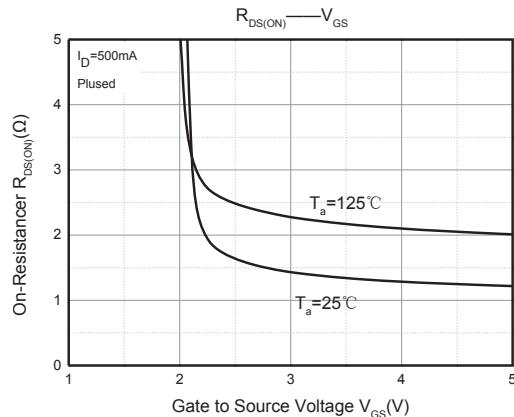
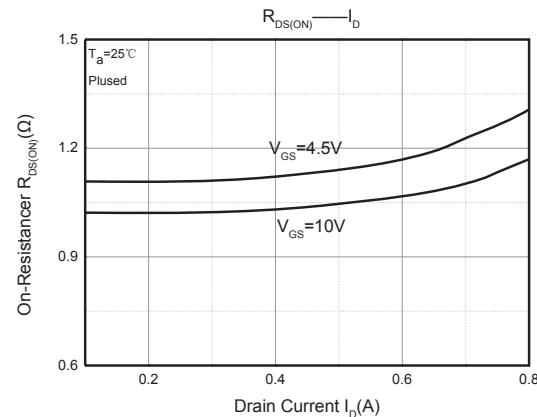
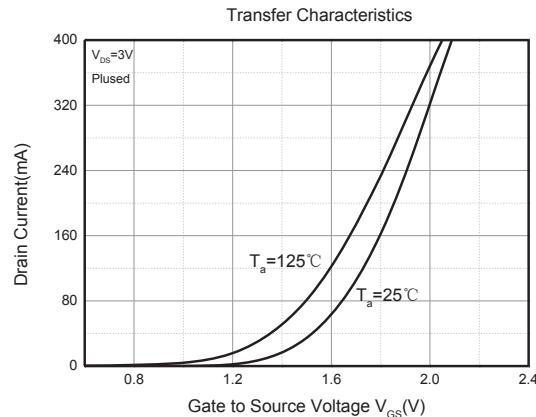
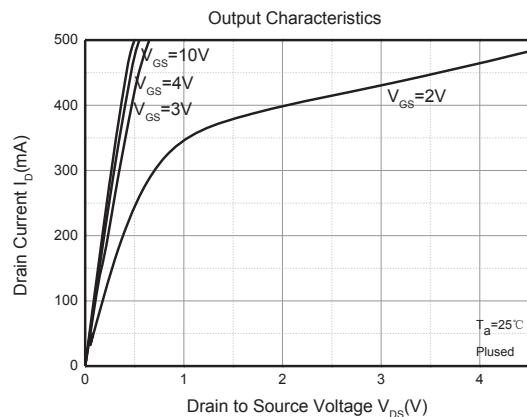
Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	50			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 0\text{V}$			0.5	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Gate threshold voltage ¹	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 1\text{mA}$	0.8	1.1	1.5	V
Drain-source on-resistance ¹	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 220\text{mA}$		0.8	2.5	Ω
		$V_{\text{GS}} = 4.5\text{V}, I_D = 220\text{mA}$		0.85	3.0	
Forward transconductance ¹	g_{FS}	$V_{\text{DS}} = 10\text{V}, I_D = 220\text{mA}$		0.15		S
Dynamic characteristics²						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		26.5		pF
Output Capacitance	C_{oss}			12.9		
Reverse Transfer Capacitance	C_{rss}			5.9		
Switching Characteristics^{1,2}						
Turn-on delay time	$t_{d(\text{on})}$	$V_{\text{DD}} = 30\text{V}, I_D = 290\text{mA}, V_{\text{GS}} = 10\text{V}, R_G = 6\Omega$			5	nS
Turn-on rise time	t_r				18	
Turn-off delay time	$t_{d(\text{off})}$				36	
Turn-off fall time	t_f				14	
Source-Drain Diode characteristics¹						
Diode Forward voltage	V_{DS}	$I_S = 440\text{mA}, V_{\text{GS}} = 0\text{V}$			1.4	V

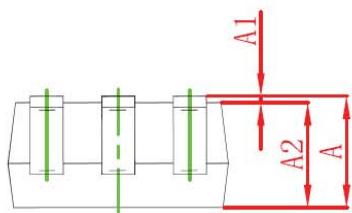
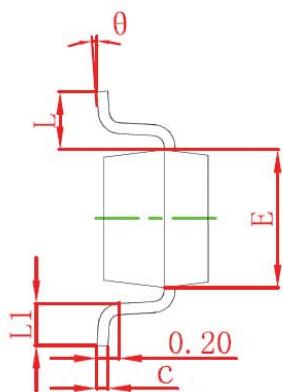
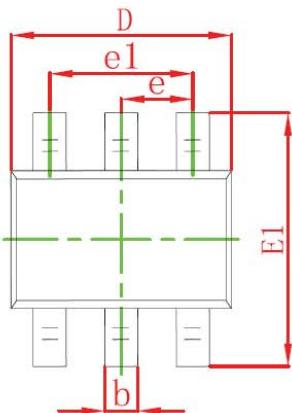
Notes:

1. Pulse Test ; Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
2. These parameters have no way to verify.

Typical Characteristics

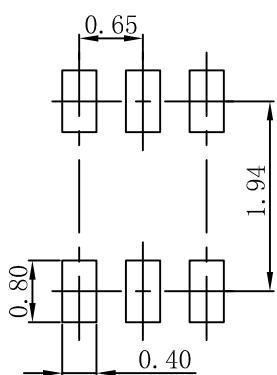


SOT-363 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.100	0.150	0.004	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.400	0.085	0.094
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

SOT-363 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

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